

CMOS Digital Integrated Circuits Silicon Monolithic

TC74ACT245F,TC74ACT640F

1. Functional Description

Octal Bus Transceiver
 TC74ACT245F:3-State, Non-Inverting
 TC74ACT640F:3-State, Inverting

2. General

The TC74ACT245F, TC74ACT640F are advanced high speed CMOS OCTAL BUS TRANSCEIVERs fabricated with silicon gate and double-layer metal wiring C2MOS technology.

They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

These devices may be used as a level converter for interfacing TTL or NMOS to High Speed CMOS. The inputs are compatible with TTL, NMOS and CMOS output voltage levels.

They are intended for two-way asynchronous communication between data busses. The direction of data transmission is determined by the level of the DIR input.

The enable input (\overline{G}) can be used to disable the device so that the busses are effectively isolated.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

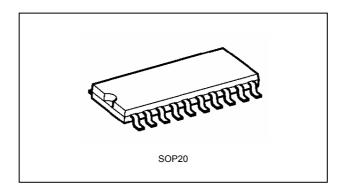
3. Features (Note)

- (1) High speed: $t_{pd} = 4.7$ ns (typ.) at $V_{CC} = 5.0$ V
- (2) Low power dissipation: $I_{CC} = 8.0 \mu A \text{ (max)}$ at $T_a = 25 \text{ °C}$
- (3) Compatible with TTL outputs: $V_{IL} = 0.8 \text{ V (max)}$, $V_{IH} = 2.0 \text{ V (min)}$
- (4) Output current: $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 4.5 \text{ V})$
- (5) Balanced propagation delays: t_{PLH} ≈ t_{PHL}
- (6) Pin and function compatible with 74F245/640.

Note: Do not apply a signal to any bus pins when it is in the output mode. Damage may result.

All floating (high impedance) bus pins must have their input levels fixed by means of pull-up or pull-down resistors.

4. Packaging

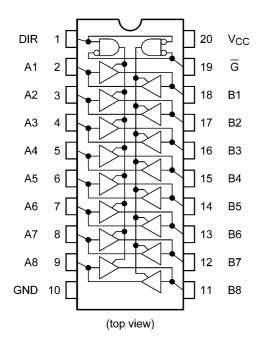


Start of commercial production

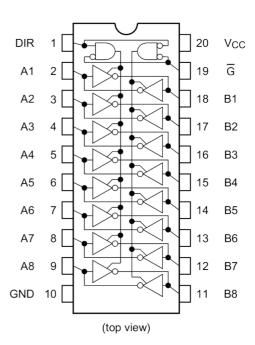


5. Pin Assignment

TC74ACT245F

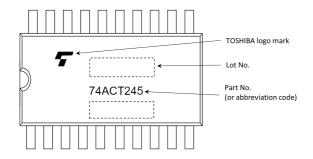


TC74ACT640F

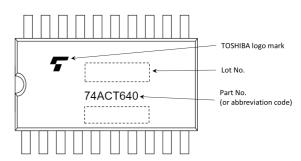


6. Marking

TC74ACT245F



TC74ACT640F

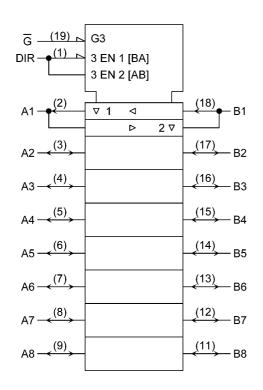


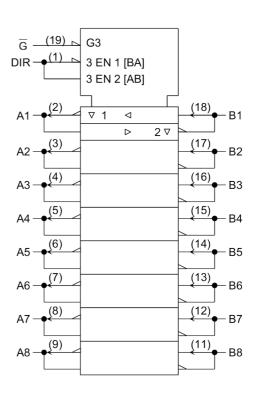


7. IEC Logic Symbol

TC74ACT245F

TC74ACT640F





8. Truth Table

Inputs G	Inputs DIR	Function A BUS	Function B BUS	Outputs TC74ACT245FT	Outputs TC74ACT640FT
L	L	Output	Input	A = B	$A = \overline{B}$
L	Н	Input	Output	B = A	$B = \overline{A}$
Н	Х	Z	Z	Z	Z

X: Don't care

Z: High impedance



9. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	-0.5 to 7.0	V
Input voltage	V _{IN}	-0.5 to V _{CC} + 0.5	V
Output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}	±20	mA
Output diode current	l _{ok}	±50	mA
Output current	I _{OUT}	±50	mA
V _{CC} /ground current	I _{CC}	±200	mA
Power dissipation	P _D	180	mW
Storage temperature	T _{stg}	-65 to 150	°C

Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

10. Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	4.5 to 5.5	V
Input voltage	V _{IN}	0 to V _{CC}	V
Output voltage	V _{OUT}	0 to V _{CC}	V
Operating temperature	T _{opr}	-40 to 85	°C
Input rise and fall times	dt/dv	0 to 10	ns/V

Note: The operating ranges are required to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either V_{CC} or GND. Please connect both bus inputs and the bus outputs with V_{CC} or GND when the I/O of the bus terminal changes by the function. In this case, please note that the output is not short-circuited.



11. Electrical Characteristics

11.1. DC Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage	V _{IH}	_		4.5 to 5.5	2.0	_	_	V
Low-level input voltage	V _{IL}	_		4.5 to 5.5	_	_	0.8	V
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	4.5	4.4	4.5	_	V
			I _{OH} = -24 mA	4.5	3.94	_	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	4.5	_	0.0	0.1	V
			I _{OL} = 24 mA	4.5	_	_	0.36	
3-state output OFF-state leakage current	I _{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$		5.5	_	_	±0.5	μА
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		5.5	_	_	±0.1	μА
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		5.5	_	_	8.0	μА
	I _{CCT}	Per input: V _{IN} = 3.4 V Other input: V _{CC} or GND		5.5	-	-	1.35	mA

11.2. DC Characteristics (Unless otherwise specified, Ta = -40 to 85 °C)

Characteristics	Symbol	Test Condition		Note	V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_			4.5 to 5.5	2.0		V
Low-level input voltage	V _{IL}	_			4.5 to 5.5		8.0	V
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I_{OH} = -50 μ A		4.5	4.4		V
			I _{OH} = -24 mA		4.5	3.80		
			I _{OH} = -75 mA	(Note 1)	5.5	3.85	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA		4.5	_	0.1	V
			I _{OL} = 24 mA		4.5	_	0.44	
			I _{OL} = 75 mA	(Note 1)	5.5	_	1.65	
3-state output OFF-state leakage current	I _{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$			5.5	_	±5.0	μА
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND			5.5		±1.0	μА
Quiescent supply	I _{CC}	V _{IN} = V _{CC} or GND			5.5	_	80.0	μА
current	I _{CCT}	Per input: V _{IN} = 3.4 V Other input: V _{CC} or GND)		5.5	_	1.5	mA

Note 1: This spec indicates the capability of driving 50 Ω transmission lines. One output should be tested within a 10 ms maximum duration.



11.3. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Тур.	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}	(Note 2)	$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	5.0 ± 0.5	_	5.0	8.0	ns
Propagation delay time	t _{PLH} ,t _{PHL}	(Note 3)	$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	5.0 ± 0.5	_	5.7	8.5	ns
3-state output enable time	t _{PZL} ,t _{PZH}		$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	5.0 ± 0.5	_	7.3	12.3	ns
3-state output disable time	t _{PLZ} ,t _{PHZ}		$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	5.0 ± 0.5	_	6.3	9.7	ns
Input capacitance	C _{IN}		DIR, G		_	5	10	pF
Bus I/O capacitance	C _{I/O}		An, Bn		_	13	_	pF
Power dissipation capacitance	C _{PD}	(Note 1)	TC74ACT245F			38		pF
			TC74ACT640F		_	43	_	

Note 1: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

 $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/8$ (per bit)

Note 2: For TC74AC245F only Note 3: For TC74AC640F only

11.4. AC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 3$ ns)

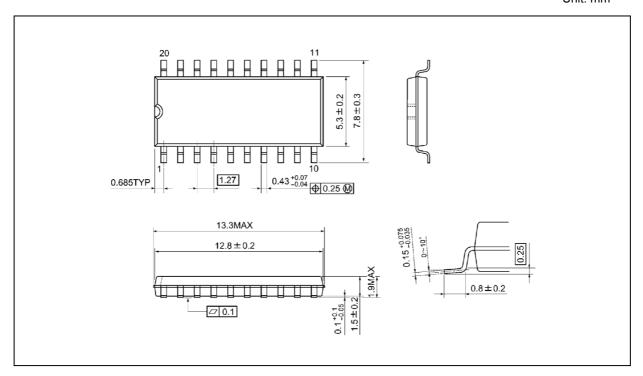
Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}	(Note 1)	$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	5.0 ± 0.5	1.0	9.0	ns
Propagation delay time	t _{PLH} ,t _{PHL}	(Note 2)	$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	5.0 ± 0.5	1.0	9.5	ns
3-state output enable time	t _{PZL} ,t _{PZH}		$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	5.0 ± 0.5	1.0	14.0	ns
3-state output disable time	t _{PLZ} ,t _{PHZ}		$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	5.0 ± 0.5	1.0	11.0	ns
Input capacitance	C _{IN}		DIR, G		_	10	pF

Note 1: For TC74ACT245F only Note 2: For TC74ACT640F only



Package Dimensions

Unit: mm



Weight: 0.22 g (typ.)

	Package Name(s)
Nickname: SOP20	



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